HVM14

Silicon Epitaxial Planar PIN Diode for High Frequency Attenuator

HITACHI

ADE-208-082C (Z) Rev. 3 May 1993

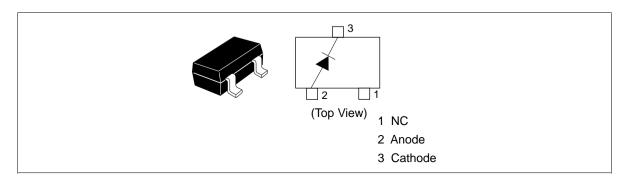
Features

- Low forward resistance. $(r_f = 7.0 \text{ max})$
- Low capacitance. (C = 0.25pFtyp)
- MPAK package is suitable for high density surface mounting and high speed assembly.

Ordering Information

Type No.	Laser Mark	Package Code
HVM14	H5	MPAK

Pin Arrangement





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Absolute Maximum Ratings (Ta = 25°C)

Item	Symbol	Value	Unit
Reverse voltage	V_R	50	V
Forward current	I _F	50	mA
Power dissipation	Pd	100	mW
Junction temperature	Tj	125	°C
Storage temperature	Tstg	-55 to +125	°C

Electrical Characteristics ($Ta = 25^{\circ}C$)

Item	Symbol	Min	Тур	Max	Unit	Test Condition
Forward voltage	V_{F}	_	_	1.0	V	$I_F = 50 \text{mA}$
Reverse current	I _R		_	100	nA	V _R = 50V
Capacitance	С	_	0.25	_	pF	V _R = 50V, f = 1MHz
Forward resistance	\mathbf{r}_{f}	_	_	7.0	Ω	I _F = 10mA, f = 100MHz
ESD-Capability	_	200	_	_	V	*C = 200pF, Both forward and reverse direction 1 pulse.

Note: Failure criterion; $I_R \ge 200$ nA at $V_R = 50$ V

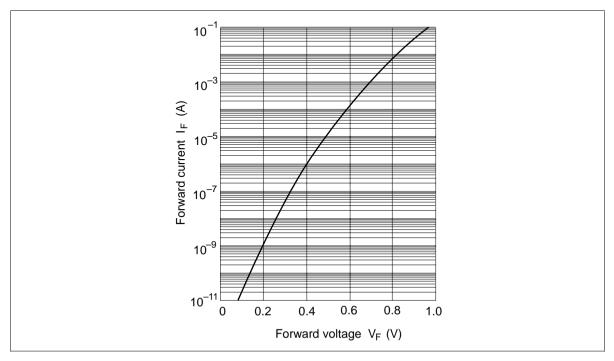


Fig.1 Forward current Vs. Forward voltage

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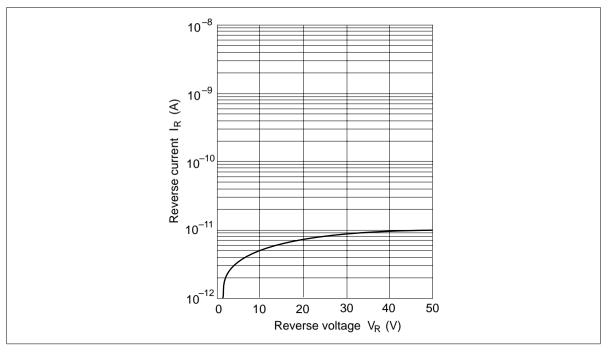


Fig.2 Reverse current Vs. Reverse voltage

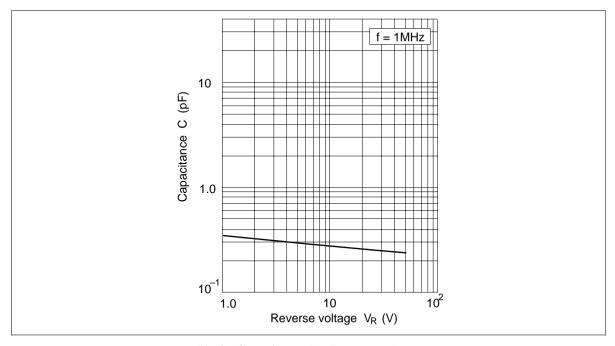


Fig.3 Capacitance Vs. Reverse voltage

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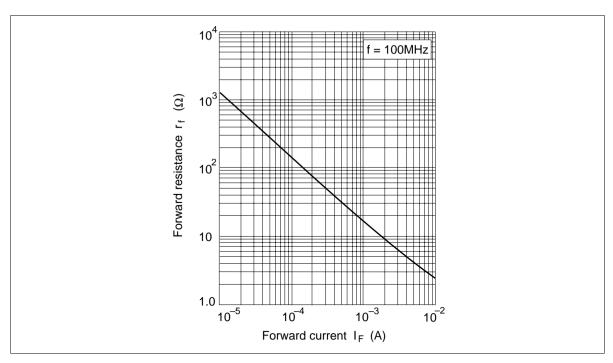
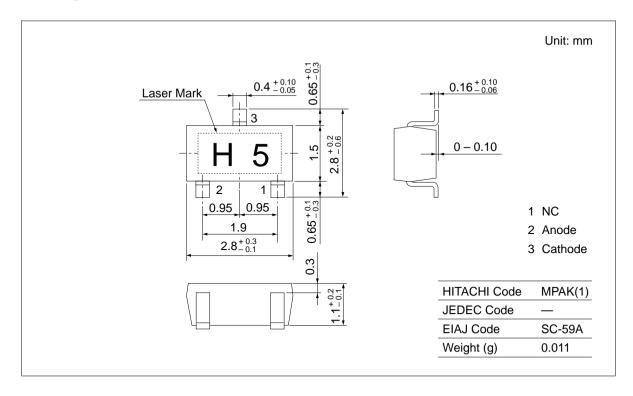


Fig.4 Forward resistance Vs. Forward current

Package Dimensions



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